Installing label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

COMPONENTS MARKED ‘DNP’ SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: 001
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANTE: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: TIDA00743</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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</thead>
<tbody>
<tr>
<td>TID #: TIDA-00743</td>
<td></td>
<td></td>
<td></td>
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<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 4/21/2017 12:53:57 PM</td>
<td>TEXAS INSTRMENTS</td>
<td></td>
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